HIGH CURRENT SI MOSFET RELAY ▲ 42 SERIES

TOWARD RELAYS

42 SERIES

5A HIGH CURRENT **A** SI MOSFET RELAY

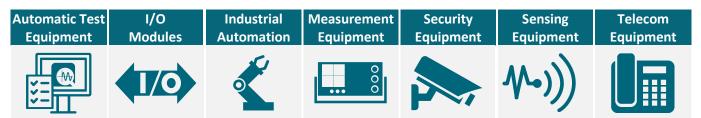
SILICON SI MOSFET RELAY ▲ DIP and SMD type Up to 5000mA ▲ Switches AC or DC load One channel and two channel packages available Input TTL / CMOS compatible Moisture Sensitivity Level ▲ MSL 3 UL 1577 approved ▲ File no E344988

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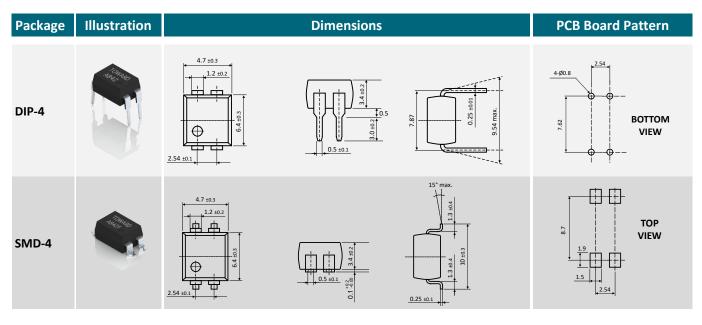
SPECIFICATION

Item		Characteristics	
Contact Form		1 Form A / 2 Form A ▲ Normally open switch	
Load Voltage	VL	60V	
Operation LED Current	I _{F ON}	3mA	
Load Current	l _L	5000mA	
On-Resistance	R _{ON}	0.02Ω	
Output Capacitance	C _{OUT}	1300pF	
Low Off-State Leakage Current	ILEAK	1µA at $60V_{DC}$	

APPLICATIONS



DIMENSIONS



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HALOGEN

FREE





DIMENSIONS

Package	Illustration		Dimensions	PCB Board Pattern
DIP-6	13 MARC	8.8 ±0.3 1.2 ±0.2 5.08	0.5 ±0.1	
SMD-6	TONIAGE A A A	8.8 ±0.3 1.2 ±0.2 1.2 ±0	15° max.	
DIP-8	Tanger	9.8 ±0.3 1.2 ±0.2 1.2 ±0.2 0.6 0.6 0.6 0.6 0.6 0.6 0.6 0.6	0.5 ±0.1	
SMD-8	TO HARD	9.8 ±0.3 9.8 ±0	15° max. 15° max. 15° max. 10° m 10° m	
SOP-4		4.3 ±0.3 	15° max. 10° ma	
SOP-8	and a second	4.3 ±0.3		C C C C C C C C C C C C C C



ABSOLUTE MAXIMUM RATINGS **A** AMBIENT TEMPERATURE T_A = 25°C

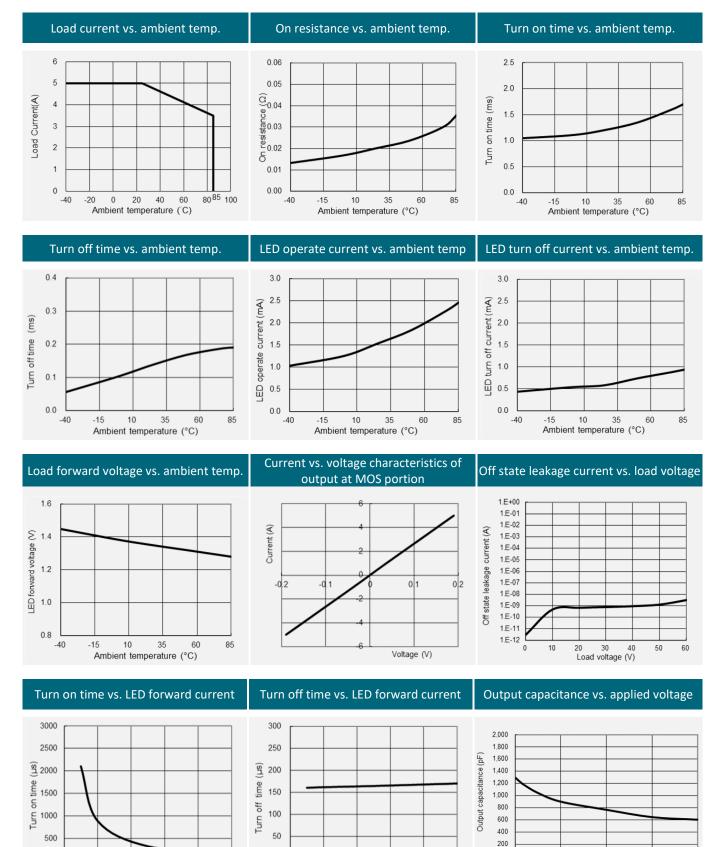
	Item	Condition	Symbol		_	Value	_	_	Unit
	Outline package			SOP-4	SOP-8	DIP-4 SMD-4	DIP-8 SMD-8	DIP-6 SMD-6	
Туре	Part number			AB42S	AC42S	AB42(F)	AC42(F)	AA42(F)	
	Output channels			1	2	1	2	1	Channels
	Continuous LED Current		IF			50			mA
lanut	Peak LED Current	100 Hz, Duty 1%	IFP			500			mA
Input	LED Reverse Voltage		VR			5			V
	Input Power Dissipation		PIN			75			mV
	Load Voltage		VL		60 (/	AC peak o	r DC)		V
Output	Load Current		IL.	2500	2000	2500	2000	5000	mA
Output	Peak Load Current	1 ms, 1 shot	Іреак	6000	6000	6000	6000	10000	mA
	Output Power Dissipation		Роит	400	450	400	450	800	mW
	Total Power Dissipation		PT	450	500	450	500	850	mW
	I/O Breakdown Voltage		V _{I/O}	1500	1500	3750	3750	3750	V _{RMS}
Relay	I/O Breakdown Voltage (Suffix-H)		Vı/o	3750	3750	5000	5000	5000	Vrms
	Operating Temperature Range		TOPR			-40 to +85	5		°C
	Storage Temperature Range		T _{STG}		-	40 to +10	D		°C

ELECTRICAL CHARACTERISTICS AMBIENT TEMPERATURE $T_A = 25^{\circ}C$

	Item	Condition	Symbol	Min.	Тур.	Max.	Unit
	LED Forward Voltage	I _F = 10mA	VF	1	1.37	1.5	V
Input	Operation LED Current		If on		1 1.7 (DIP6)	5	mA
	Recovery LED Voltage		V _{F OFF}	0.5	1.2		V
	On-Resistance				0.053	0.064	
	Drain to Drain (tested within 1 sec.)	$I_F=5mA$, $I_L=Rating$	R _{ON}		0.02 (DIP6)	0.032 (DIP6)	Ω
Output	Off-State Leakage Current	V _L = 60V	ILEAK			1	μA
	Output Capacitance	VL=0V, f=1MHz	Соит		400 1300 (DIP6)		pF
	Turn-On Time (for SOP/DIP4,8 type)	$I_F=5mA$, $I_L=Rating$	ton		0.8	3	ms
Trans-	Turn-Off Time (for SOP/DIP4,8 type)	I_F =5mA, I_L =Rating	toff		0.15	0.5	ms
mission	Turn-On Time (for DIP6 type)	I_F =10mA, I_L =Rating	ton		1.2	3	ms
	Turn-Off Time (for DIP6 type)	I_F =10mA, I_L =Rating	toff		0.15	0.5	ms
Coupled	I/O Insulation Resistance		Rı/o	10 ⁹			Ω
Coupled	I/O Capacitance	f=1MHz	CI/O		1.3		рF



REFERENCE DATA A DIP-4/DIP-6/DIP-8/SMD-4/SMD-6/SMD-8



40

30

10 20 Applied voltage (V)

0

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10 20 30 LED forward current (mA)

40

50

0

0

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10

20

LED forward current (mA)

30

40

50

0

0

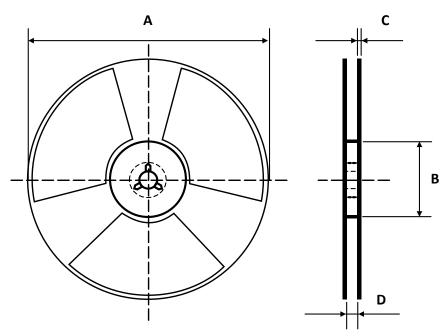


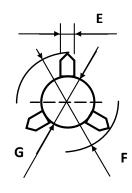
PIN DESCRIPTION AND PART NUMBER

Circuit Diagram	Pir	Description	Part No.	Package	Packing
	1 2 3,4	Anode (+) • LED Cathode (-) • LED Drain • MOSFET	AB42 AB42F AB42S AB42F-R1 AB45S-R1	DIP-4 SMD-4 SOP-4 SMD-4 SOP-4	Tube (90pcs) Tube (90pcs) Tube (100pcs) Reel (1000pcs) Reel (1000pcs)
	1 2 3 4,6 5	Anode (+) • LED Cathode (-) • LED NC Drain • MOSFET Source • MOSFET	AA42 AA42F AA42F-R1	DIP-6 SMD-6 SMD-6	Tube (50pcs) Tube (50pcs) Reel (1000pcs)
	1,3 2,4 5,6,7,8	Anode (+) • LED Cathode (-) • LED Drain • MOSFET	AC42 AC42F AC42S AC42F-R1 AC42S-R1	DIP-8 SMD-8 SOP-8 SMD-8 SOP-8	Tube (45pcs) Tube (45pcs) Tube (50pcs) Reel (1000pcs) Reel (1000pcs)



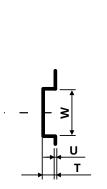
REEL DIMENSIONS All dimensions in mm

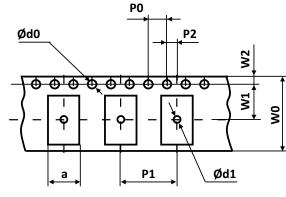


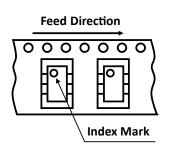


Size	А	В	С	D	E	F	G
SOP-4	330	100	2	13	2	13	21
SOP-8	330	100	2	17	2	13	21
SMD-4	380	80	2.2	17	2	13	21
SMD-6	380	80	2.2	17	2	13	21
SMD-8	380	80	2.2	17	2	13	21

TAPE DIMENSIONS All dimensions in mm







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Size	w	U	т	а	Ød0	Ød1	P0	P1	P2	W0	W1	W2
SOP-4	4.6	0.3	2.3	7.2	1.5	1.5	4	12	2	12	7.5	1.75
SOP-8	10.4	0.3	2.3	7.5	1.5	1.5	4	12	2	16	7.5	1.75
SMD-4	5.3	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75
SMD-6	9.15	0.3	4.45	10.4	1.5	1.5	4	16	2	16	11.5	1.75
SMD-8	9.9	0.3	4	10.6	1.5	1.5	4	16	2	16	7.5	1.75

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PACKING QUANTITIES

Tape and Reel Packing	PCS/Reel
SMD-4	1000
SMD-6	1000
SMD-8	1000
SOP-4	1000
SOP-8	1000

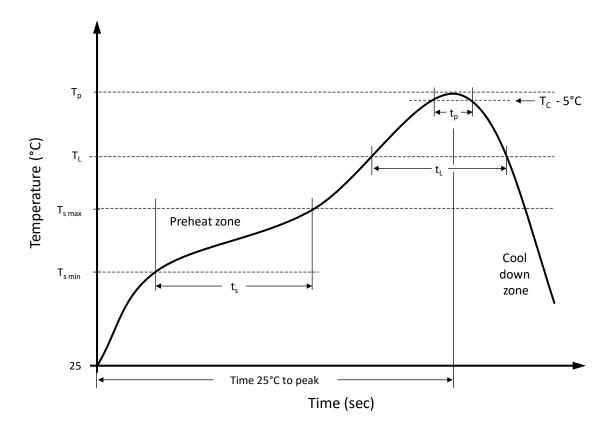
Tube Packing	PCS/Tube	Tubes/Box	Units/Box
DIP-4	90	30	2 700
DIP-6	50	30	1500
DIP-8	45	30	1350
SMD-4	90	30	2 700
SMD-6	50	30	1500
SMD-8	45	30	1350
SOP-4	100	30	3000
SOP-8	50	30	1500

STORAGE AND HANDLING CONDITIONS

ESD level	Floor life	Conditions	MSL
HBM class 2	Unlimited	T _A < 30°C, RH < 85%	1



RECOMMENDED REFLOW SOLDERING PROFILE A SMD PACKAGE



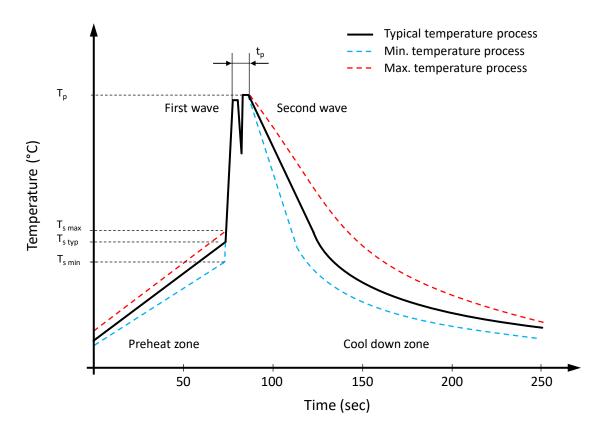
Recommended reflow soldering conditions ▲ **Refer to JEDEC J-STD-020E**

Profile Features		Sn-Pb Eutetic Assembly	Pb-Free Assembly
Preheat temperature min.	Ts min	100 °C	150 °C
Preheat temperature max.	$T_{s max}$	150 °C	200 °C
Preheat time ts from Ts min to Ts max	ts	120 seconds	120 seconds
Ramp-up rate (T_L to T_p)		max. 3 °C/second	max. 3 °C/second
Liquidous temperature	ΤL	183 °C	217 °C
Time t_L maintained above T_L	t∟	150 seconds max.	60 seconds max.
Peak package body temperature	Tp	235°C	260°C
Timeframe of within 5°C below and up to max actual peak body temperature	tp	20 seconds max.	30 seconds max.
Ramp-down rate (T_L to T_p)		max. 6 °C/second	max. 6 °C/second
Time 25°C to peak temperature		max. 6 minutes	max. 8 minutes

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RECOMMENDED WAVE SOLDERING PROFILE ▲ THT PACKAGE



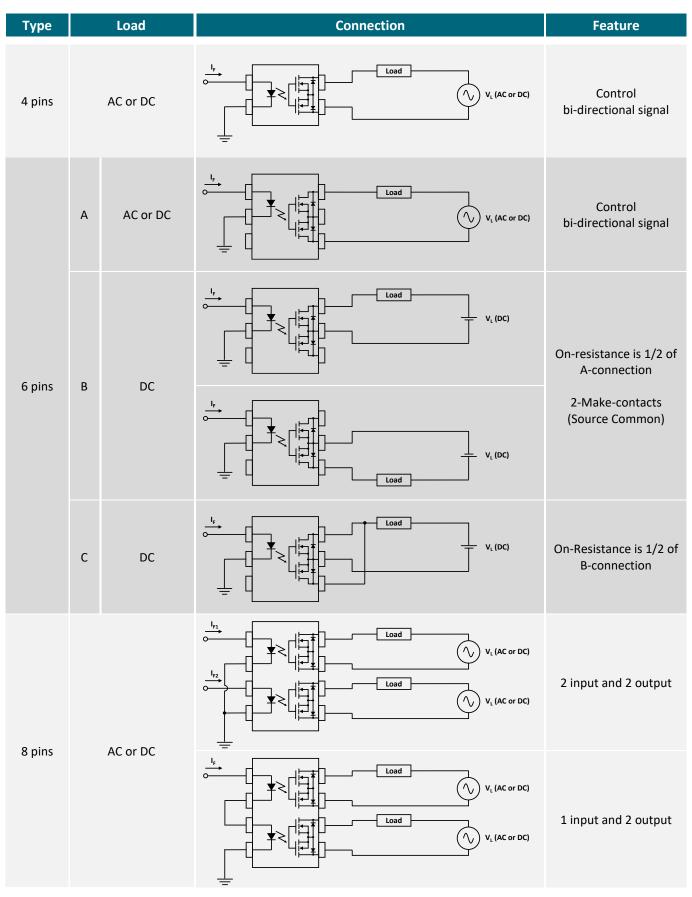
Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value A Pb-free Assembly
Preheat temperature min.	T _{s min}	100 °C	100 °C
Preheat temperature typical	T _{s typ}	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time t_s from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	tp	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes



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LOAD CONNECTING METHOD



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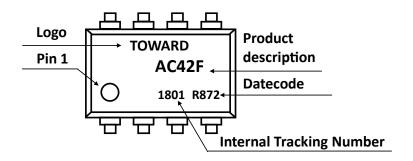
PRODUCT CODE

Example: AC42F series \blacktriangle 2 Form A \blacklozenge 60V \blacklozenge SMD-8 \bigstar Tape & Reel

AC		42		-		F		R1	
Package		Series		Sp	ecial Suffix	Туре		Packing	
AA AB AC	6 Pin ▲ 1 Form A 4 Pin ▲ 1 Form A 8 Pin ▲ 2 Form A	42	60V	Blank H	Standard High Insulation	Blank F	DIP SMD SOP	Blank R1	Tube Reel

PRODUCT MARKING

Example: AC42F series \blacktriangle 2 Form A \blacklozenge 60V \bigstar SMD-8 \bigstar Tape & Reel



DATE CODE

Example: R872

F	2	8	3	7	7		2
Material Characteristics		Year		Month		Week of the Month	
R H	RoHS compliant Halogen free	8 9 A B C G	2018 2019 2020 2021 2022 2026	1 2 3 4 5 	Jan Feb Mar Apr May Dec	1 2 3 4	1 st 2 nd 3 rd 4 th



RELIABILITY TESTS A STANDARD

Standard: JESD22-A

No.	Test	Test Specification	Test Standard	Test Limits
1	Moisture Sensitivity Level Test	Bake condition: Temperature: 125°C; Duration 24 hours Soak condition: Temperature: 30°C; Humidity: 60% RH Duration 192 hours Reflow condition: Peak temperature: 260°C Duration: 3 cycles	JESD22-A113H	No abnormal phenome- non was found. Functional test passed.
2	High Temperature Storage Test	Temperature: 150°C Duration: 500 hours	JESD22-A103E	No abnormal phenome- non was found. Functional test passed.
3	Temperature Cycling Test	Temperature range: -55°C to +125°C -55°C for 30 minutes +125°C for 30 minutes Duration: 100 cycles with 1 cycle = 70 minutes	JESD22-A104E	No abnormal phenome- non was found. Functional test passed.
4	Low Temperature Storage Test	Temperature: -40°C Duration: 500 hours	JESD22-A119E	No abnormal phenome- non was found. Functional test passed.
5	Temperature & Humidity Storage Test	Temperature: 85°C Humidity: 85% RH Duration: 500 hours	JESD22-A101D	No abnormal phenome- non was found. Functional test passed.
6	Highly Accelerated Temperature and Humidity Stress Test	Temperature: 130°C Humidity: 85% RH Duration: 96 hours	JESD22-A-118B	No abnormal phenome- non was found. Functional test passed.

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REVISION TABLE

Revision	Date	Status	Notes
001	01/04/2022	Initial release	Initial publication

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